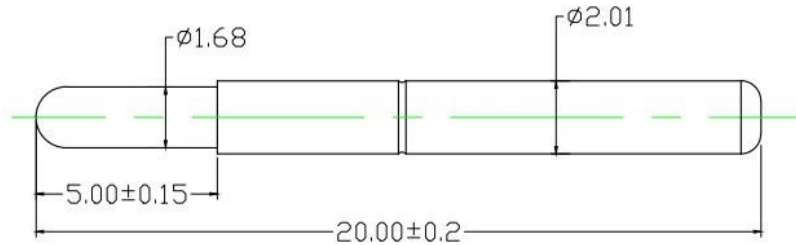


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| | |
|----------|----------------------------|
| □□ □□ | SF-P125-J |
| □□ | 1.90mm |
| □□ □□ □□ | □□□:1.35 □□ □□ □:1.40mm |
| □□□□□ | 4.5mm |
| □□□ □ | 180±20%gf@load4.5mm |
| □□ □□□ | 3A |
| □□ □□ | 50mΩ □□ |
| MOQ | 100PCS |
| □□ | □/□ |
| □□ □□ | □□□□ □□ □ 5~10□ |

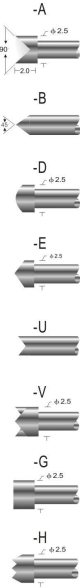
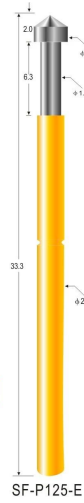
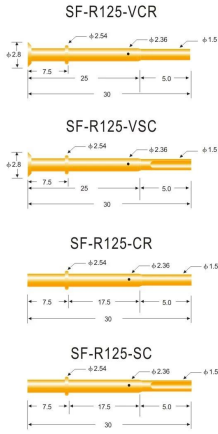
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Materials(Plated) (材質與鍍層):
 Barrel(針套) : Brass(黃銅) , Au on Ni Plated
 Plunger(針軸) : Brass(黃銅) , Ni Plated
 Spring(彈弓) : SUS (不銹鋼線) , /

Specifications (技術要求):
 Full Stroke(滿沖程) : 4.5mm
 Spring Force(彈力) : 180±20%gf@ load 4.5mm

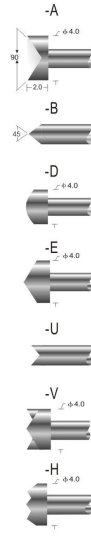
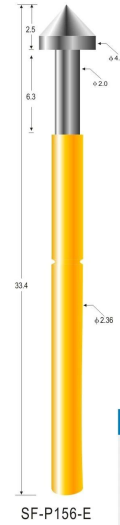
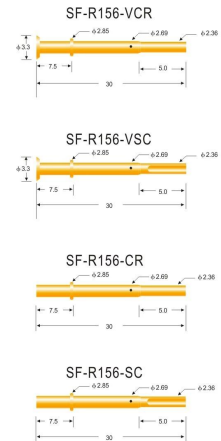
| | | | | | | | | | | |
|----|----|-------|-----|------------|-----------------------|----|----|----|---|-------|
| | | | | | 名称: SF-P125-J(L20) | | | | 胜峰科技 | |
| | | | | | | | | | 说明: 1.所有尺寸单位为mm 2.未注图示尺寸公差:按GB1804-79 11级精度执行 | |
| 标记 | 处数 | 更改文件号 | 签字 | 日期 | 图样 | 标记 | 视图 | 质量 | 比例 | 图纸编号: |
| 设计 | | | 标准化 | | S | A | ⊕ | | 1:1 | |
| 校对 | | | 审定 | | | | | | | |
| 审核 | | | 制图 | RSS | | | | | | |
| 工艺 | | | 日期 | 2020-09-24 | 共 | 1 | 页 | 第 | 1 | 页 |



Probe specifications SF-P125(技术规格)

- Recommended minimum center(最小间距): 3.17mm(.1248")
- Mounting hole size(钻孔尺寸): 压克力: 2.40mm(.0945") 电木板、玻璃纤维板: 2.45mm(.0965")
- Full travel(行程): 6.30(.2480")
- Spring force(弹簧压力): 200g
- Materials and finishes(材料及涂饰): Plunger: Be Cu, Rh plated; Barrel: Brass, Gold plated; Spring: Stainless steel
- Current rating(额定电流): 5A(安培)
- Contact resistance(接触电阻): 50mΩ(毫欧姆)
- Connections(接线形式): Crimp: R125-VCR, R125-CR Solder cup: R125-VSC, R125-SC

Noted: Specifications subject to change without notice(注: 规格变动不另行通知)



Probe specifications SF-P156(技术规格)

- Recommended minimum center(最小间距): 4.75mm(.1870")
- Mounting hole size(钻孔尺寸): 压克力: 2.75mm(.1083") 电木板、玻璃纤维板: 2.80mm(.1102")
- Full travel(行程): 6.30(.2480")
- Spring force(弹簧压力): 250g
- Materials and finishes(材料及涂饰): Plunger: Be Cu, Rh plated; Barrel: Brass, Gold plated; Spring: Stainless steel
- Current rating(额定电流): 5A(安培)
- Contact resistance(接触电阻): 50mΩ(毫欧姆)
- Connections(接线形式): Crimp: R156-VCR, R156-CR Solder cup: R156-VSC, R156-SC

Noted: Specifications subject to change without notice(注: 规格变动不另行通知)





1. raw material warehouse



2. Lathe workshop



3. Assemble workshop



4. Quality inspection



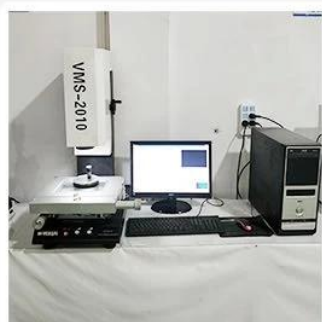
5. Finished products



6. Packing



Measuring Equipment >



Measuring Equipment:

1. Agilent current testing;
2. Quadratic element measurement
3. Load Curve Meter
4. Bond Test
5. Life Fatigue Test





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1. PCB, ICT, FCT [[[[[[[[[[[[([[);
2. [[, [[[[, [[[[, [[[[[[[[[[[[[[[[[[[[[[[[[[[[[[[[([[);
3. BGA [[[[[[[[[[[[[[;
4. [[[[[[[[, [[[[, QZ [[VZ [[[[LM [[;
5. [[[[, [[[[, [[[[[[[[;
6. [[[[[[/ [[;
7. [[[[[[[[, [[[[[[, POM [[[[.

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2. [[[[[[[[[[OEM [[[[.
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